COUPLED SIMULATIONS OF MECHANICAL DEFORMATION AND MICROSTRUCTURAL EVOLUTION USING POLYCRYSTAL PLASTICITY AND MONTE CARLO POTTS MODELS

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ABSTRACT

The microstructural evolution of heavily deformed polycrystalline Cu is simulated by coupling a constitutive model for polycrystal plasticity with the Monte Carlo Potts model for grain growth. The effects of deformation on boundary topology and grain growth kinetics are presented. Heavy deformation leads to dramatic strain-induced boundary migration and subsequent grain fragmentation. Grain growth is accelerated in heavily deformed microstructures. The implications of these results for the thermomechanical fatigue failure of eutectic solder joints are discussed.

INTRODUCTION

Thermal fluctuations during the normal course of service or storage can accelerate the failure of solder joints in electronic components [1]. This thermomechanical fatigue (TMF) of solder joints involves a number of different processes acting in concert. Thermal expansions and contractions of the surrounding pieces generate a complex state of stress in the joint. The local details of that stress state, and the properties of the solder microstructure, create regions of high localized strain in the joint. These localized deformations induce coarsening in the microstructure, which weakens the material. These weakened regions fatigue as the thermal fluctuations continue, eventually leading to component failure. This phenomenon has been observed, for example, as satellites pass into and out of the sun's rays, or when stored components are subjected to daily and seasonal temperature changes.

Understanding TMF requires an examination of how each process operates individually and in conjunction with the other processes. In this paper, we examine the effects of the localized deformation on the evolution of a polycrystal microstructure. Solder joints are typically composed of eutectic PbSn, but we will use pure polycrystalline Cu as a proof-of-concept system for the present study. The deformation of the material is simulated using the finite element method (FEM) with a constitutive law for polycrystal plasticity fit to experimental data for Cu. This polycrystal plasticity model predicts the local mechanical state of the system, and this information is combined with the Monte Carlo Potts model to simulate grain growth (i.e., microstructural coarsening) in the deformed material. The polycrystal plasticity and Potts models will be outlined briefly, and the extension of the Potts model to account for stored strain energies will be discussed. The effects of deformation on the evolution of the microstructure will be presented, and the implications of these results for the TMF of solder joints will be addressed.

SIMULATION METHODS

Polycrystal Plasticity

The polycrystal plasticity model will be described here only in brief, and the reader is referred elsewhere [2,3] for a more detailed discussion. The local states of stress and strain in the Cu polycrystal are simulated using FEM with a constitutive law for polycrystal plasticity fit to experimental data for Cu. The finite element mesh is generated by discretizing a polycrystal microstructure onto a cubic lattice. Each lattice site is associated with a spatial orientation, and a cluster of lattice sites with the same orientation represents a grain. Each lattice site represents an element in the finite element mesh, and the nodes of the mesh form a cubic grid occupying the corners of the elements. Ideally, the polycrystal microstructure would correspond directly to the real Cu sample to which the plasticity model was fit. However, for the purpose of the present study, the microstructure was taken from a conventional 3D Potts model simulation, and the
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orientations of the grains are assigned at random. The constitutive model for the mechanical response of a polycrystal tracks the spatial orientations of the material at each element, and the material deformations on each of the twelve FCC slip systems. The elastic response of the material is anisotropic, and the plastic response is strain rate dependent such that $\tau = \dot{\gamma}^m$, where $\tau$ is the shear stress, $\dot{\gamma}$ is the shear strain rate, and $m$ is the strain rate sensitivity exponent. In this study, an exponent of $m = 10$ was used. Each of the twelve slip systems hardens isotropically according to a power law,

$$d\tau = \tau_0 + A\dot{\gamma}^n,$$

where $\tau_0$ is the initial critical resolved shear stress, $\dot{\gamma}$ is the effective plastic shear strain, and $A$ and $n$ are parameters fit to the experimental stress-strain response of a Cu polycrystal. All slip systems are initialized to the same critical resolved shear stress and harden equally. However, the polycrystal evolves an anisotropic mechanical response during deformation due to the variations in geometric constraints between and within grains.

The plasticity simulation is performed on a 54-grain polycrystal microstructure mapped onto a 30x30x30-element mesh. The average grain size is about 500 elements. Each element is cubic before deformation. The initial element orientations in each grain are the same (random) value, and the stress and strain values at each element set to zero. Periodic boundary conditions are imposed in all three directions. Deformation is simulated by a prescribed elongation of the simulation cell in one direction, with zero net force in the other two directions. The elongation of the simulation cell is increased in increments of 0.001%. At each strain increment, the mechanical state of the system is equilibrated. The stress and strain increments on each slip system in each element are used to calculate the stored plastic energy, which is input to a Monte Carlo Potts model of microstructure evolution, as described below. (Stored elastic energy is relatively small at the deformations of interest, and is therefore neglected in the present study, though it may be important under certain circumstances.)

**Microstructural Evolution**

The evolution of the deformed microstructures is simulated using a Monte Carlo Potts model [4,5] modified to account for the plastic energy stored in the material during deformation. The finite element mesh is input directly to the Potts simulation. Each grain on the mesh is assigned a unique integer identity, or “spin,” and all the elements in a grain assume the spin of that grain. Periodic boundary conditions are imposed in all directions. Each element contains twelve slip systems for which the twelve shear stress and strain increments are taken from the polycrystal plasticity model.

The system energy is described by a modified Potts Hamiltonian,

$$H = \sum_{i=1}^N \left\{ \frac{E_o}{2} \sum_{j=1}^{26} \left[ 1 - \delta(s_i, s_j) \right] + \frac{1}{V_i \tau_0} \sum_{\Delta l=0}^{\Delta l} \sum_{\alpha=1}^{12} \tau_i(\alpha, \Delta l) \Delta \gamma_i(\alpha, \Delta l) \right\}.$$  

The sum over $i$ includes all of the $N$ elements in the mesh, and the sum over $j$ includes all of the 26 elements that share at least one node with element $i$. (Recall that the mesh is initially cubic, and thus the element connectivity of the deformed mesh is that of a cubic grid.) The sum over $\Delta l$ includes all elongation increments up to the elongation of interest, $\Delta l_o$, and the sum over $\alpha$ includes all twelve slip systems in element $i$. $E_o$ is a measure of the grain boundary energy, and is assumed to be unity for all boundaries in this study. $s_i$ is the spin of element $i$, and $\delta(s_i, s_j)$ is the Kronecker delta, i.e., $\delta(s_i, s_j) = 1$ if $s_i = s_j$ and 0 otherwise. $V_i$ is the volume of element $i$, $\tau_0$ is the initial critical resolved shear stress, $\tau(\alpha, \Delta l)$ is the average plastic shear stress on slip system $\alpha$ in element $i$ at elongation $\Delta l$, and $\Delta \gamma(\alpha, \Delta l)$ is the plastic shear strain increment on slip system $\alpha$ in element $i$ at elongation $\Delta l$. The first term in Equ. 2 represents the grain boundary energy, and the second describes the stored plastic energy.

The Monte Carlo Potts simulation proceeds by choosing an element at random and attempting to change its spin to that of one of its neighbors. When an element changes its spin to
that of a different grain, the stored plastic energy in that element is changed to the average of the values at the neighboring elements that belong to that different grain. This implies that, when a grain boundary moves, nearly all of the dislocations adjacent to the boundary are extended into the material through which the boundary migrates. However, this is not always the case in reality. On the other hand, if no dislocations were propagated with the boundary, then a new grain would be introduced and the material would recrystallize. Though recrystallize undoubtedly occurs, and is certainly important in the materials of interest and at these levels of deformation, it is not the only option. A grain boundary can simply migrate in a heavily deformed polycrystal [6]. The migration of a grain boundary in a deformed polycrystal involves the propagation of some, but not always all, of the dislocations that are adjacent to it. However, a meaningful quantitative description of how the dislocation structure propagates with a migrating grain boundary is not currently available, and thus we assume that nearly all the dislocations are carried with a boundary when it moves.

The change in the system energy that results from an attempted spin “flip” is computed using Equ. 2, and the spin flip is accepted if the energy change is less than or equal to zero, and rejected otherwise. This is repeated until no more energy-decreasing spin flips are available. This pseudo-kinetic approach corresponds to the zero-temperature Metropolis Monte Carlo algorithm [7], though in practice we use a more efficient version [8,9]. The evolution of the microstructure (without deformation) toward its equilibrium reproduces the kinetics of normal grain growth remarkably well [10].

RESULTS AND DISCUSSION

The temporal evolution of the microstructure after 31% elongation is shown pictorially in Fig. 1. The black lines denote the grain boundaries. The shading corresponds to the stored plastic energy in each element, with dark regions representing low stored energy values and light regions indicating high values. As evident in Fig. 1, the grain boundaries roughen as they migrate and the grains fail to remain compact. This phenomenon is also observed experimentally [6] in deformed polycrystals, and is commonly termed strain-induced boundary migration (SIBM). SIBM occurs when two adjacent grains have very different dislocation densities (i.e., stored plastic energies). If the difference is much larger than the grain boundary energy, then the only significant driving force for grain boundary migration is the reduction in stored energy provided by the consumption of high-strain material by adjacent low-strain grains. Under these circumstances, grains are not motivated to remain compact and grain boundaries roughen, as seen in Fig. 1 and observed experimentally [6].

Figure 1. Evolution of the stored plastic energy during grain growth after 31% elongation. The stored energy distribution is shown at three simulation times in Monte Carlo steps (mcs). Dark areas have low stored energy and light areas have high energy. The scale bar at the right indicates normalized strain energy densities as per the second term in Equ. 2.
At elongations larger than 31\%, SIBM becomes even more pronounced. At lower elongations, grains remain compact and the evolution of the microstructure more closely resembles normal grain growth, but boundary motion is still influenced by the stored energy in the material. This strain-enhanced boundary migration (SEBM) occurs when the driving forces due to grain boundary energy and stored plastic energy are comparable. This situation applies at 11\% elongation, as depicted in Fig. 2, where grain growth appears normal but is dominated by material with relatively little stored plastic energy.

The grains that dominate the growth process at higher deformations aren’t always the ones with the least stored plastic energy, since the plastic driving force for grain growth relies on the differences in stored energy between adjacent grains, and not on the absolute value of the stored energy. Therefore, the large grain in the last frame of Fig. 1 is lighter in shading (i.e., higher in stored plastic energy) than the grains that it surrounds. The same can be true for lower deformations, except that the significance of the curvature driving force (represented by the first term in Equ. 2) complicates the issue further.

By examining the time values in Figs. 1 and 2, one can readily see that the 31\% elongated polycrystal coarsens much more quickly (by an order of magnitude) than does the 11\% elongated structure. This is shown graphically in Fig. 3 which contains plots of the grain size evolution and the time required to reach an average grain radius of 10 elements, for various elongations. At large elongations in Fig. 3a, the average grain size decreases at early times as SIBM causes grains become non-compact and to fragment. At later times, the rate of grain growth increases with increasing elongation, so that the time required to achieve an average grain radius of ten elements decreases with increasing elongation, as in Fig. 3b.

Post mortem analyses of failed solder joints suggests that accelerated coarsening in regions of high local deformation leads to mechanical weakening and eventually failure of the joint [1]. The results presented in Fig. 3 support a part of this evidence by indicating that coarsening in single-phase polycrystals can be dramatically accelerated by deformation. As mentioned above, the plastic response of the simulated polycrystal is modeled after pure Cu. However, the material used in many real-world components is eutectic PbSn solder. Coarsening in eutectics generally involves interphase diffusion, which cannot be captured by a model of single-phase grain growth. Therefore, these results should be taken primarily as a demonstration of the modeling approach.

**SUMMARY**

Microstructural evolution in a 54-grain region of a deformed Cu polycrystal was simulated by coupling a constitutive finite element model of polycrystal plasticity with the Monte Carlo Potts model of grain growth. Heavy deformation introduces high stored plastic energies into the material which dominate the grain growth process. In this regime, grains are not motivated to remain compact, and strain-induced boundary motion leads to grain boundary roughening and grain

![Figure 2. Evolution of the stored plastic energy during grain growth after 11\% elongation. The stored energy distribution is shown at three simulation times in Monte Carlo steps (mcs). Dark areas have low stored energy and light areas have high energy. The scale bar at the right indicates normalized strain energy densities as per the second term in Equ. 2.](image-url)
Figure 3. Grain growth kinetics: a) the average grain radius as a function of Monte Carlo time for four elongation values, and b) the Monte Carlo time required to achieve an average grain radius of ten elements as a function of the elongation. Error bars correspond to standard deviations of forty grain growth simulations at each elongation.

fragmentation. The additional driving force of the stored plastic energy serves to increase the coarsening rate with increasing deformation. This provides some insight into the thermomechanical fatigue failure of solder joints, which is precipitated by accelerated coarsening in locally deformed regions of the microstructure.

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REFERENCES